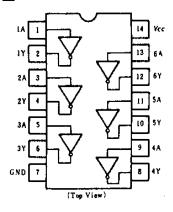
# HD74LS04/HD74LS05 \*Hex Inverters (with Open Collector Outputs)

# ECIRCUIT SCHEMATIC(1/6)

# HD74LSO5 Output A Output 4.5k

### **MPIN ARRANGEMENT**



## **■**HD74LS05 RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
High level output voltage	Von	-	_	5.5	v
Low level output current	lог	_	-	8	mA

## **ELECTRICAL CHARACTERISTICS** ( $Ta = -20 \sim +75 ^{\circ}\text{C}$ )

GND

		ymbol Test Conditions		HD74LS04			HD74LS05			P7
Item	Symbol			min	typ*	max	min	typ*	max	Unit
	Vin			2.0			2.0		-	١
Input voltage	VIL			_		0.8	1	_	0.8	1
1. Sec. 19. 14. (1991)	Voн	$V_{CC} = 4.75 \text{V}, V_{IL} = 0.8 \text{V}, I_{OH} = -400 \mu\text{A}$		2.7	_	_		_	_	1
Output voltage		$V_{CC}=4.75V,  V_{IH}=2V$	IoL = 8mA	_	_	0.5	_	T -	0.5	∤ v
	Vol		IoL=4mA	_	_	0.4	_	<u> </u>	0.4	
Output current	Іон	$V_{CC} = 4.75V, V_{IL} = 0.8V, V_{OH} = 5.5V$			_		_	T -	100	μ.
	In	$V_{CC} = 5.25 \text{V},  V_I = 2.7 \text{V}$		-	_	20	_		20	μ
Input current	Itz	$V_{CC} = 5.25 \text{V},  V_I = 0.4 \text{V}$		_	_	-0.4	_	_	-0.4	m
	Iı	$V_{cc} = 5.25 \text{V},  V_{l} = 7 \text{V}$			-	0.1			0.1	m
Short-circuit output current	los	Vcc = 5.25V		-20	_	- 100	_	_		m
Іссн			- 1.2	2.4	_	1.2	2.4	m.		
Supply current	<i>Icc</i> ı	$V_{CC}=5.25$ V			3.6	6.6		3.6	6.6	
Input clamp voltage	Vik	$V_{CC} = 4.75 \text{V},  I_{IN} = -18 \text{mA}$		_	_	-1.5	_		-1.5	

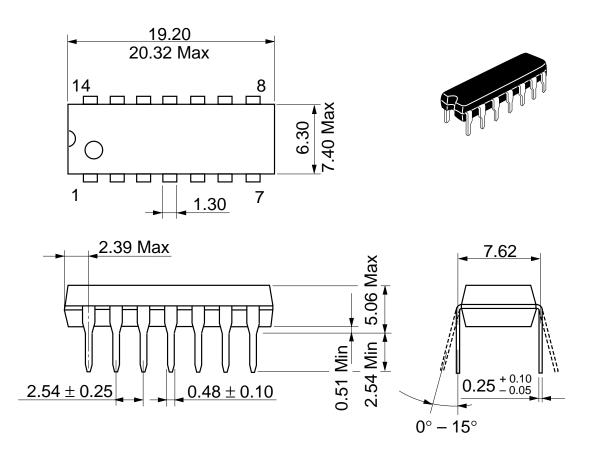
<sup>\*</sup> VCC=5V, Ta=25°C

## **ESWITCHING CHARACTERISTICS** ( $V_{CC}=5V$ , $T_a=25^{\circ}C$ )

Item	Symbol	Tr A C Stat	HD74LS04			HD74LS05			Unit
		Test Conditions		typ	max	min	typ	max	Unit
Propagation delay time	tplh	$C_L=15 \mathrm{pF}, \ R_L=2 \mathrm{k}  \Omega$		9	15	_	17	32	ns
	tPHL		ı	10	15	_	15	28	

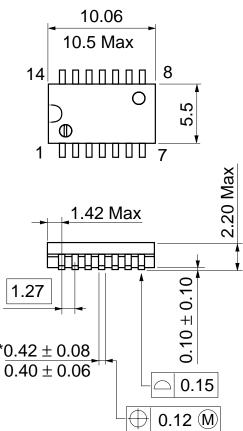
Note) Refer to Test Circuit and Waveform of the Common Item

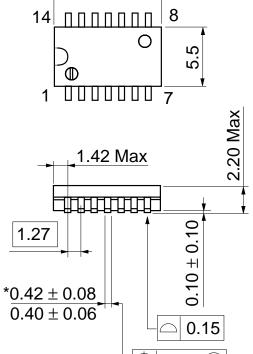
Unit: mm



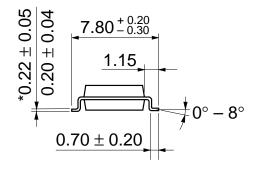
Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g

Unit: mm





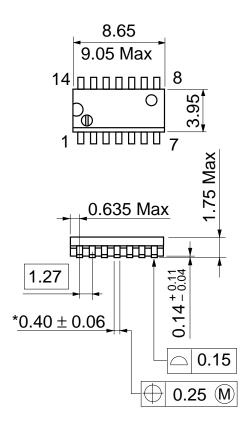




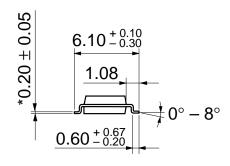
Hitachi Code	FP-14DA
JEDEC	
EIAJ	Conforms
Weight (reference value)	0.23 g

Dimension	including	the	plating	thickness
Bas	se materia	al dir	mensioi	1

Unit: mm







Hitachi Coo	de	FP-14DN	
JEDEC		Conforms	
EIAJ		Conforms	
Weight (refe	erence value)	0.13 g	

\*Pd plating

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